

Microchip**Filter specification****TFS 174G****1/5****Measurement condition**

Ambient temperature:	23	°C
Input power level:	0	dBm
Terminating impedance: *		
Input:	390 Ω	-7 pF
Output:	285 Ω	-8 pF

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS 174G is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_c is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed at 174,0 MHz without any tolerance. The given values for both the relative attenuation a_{rel} and the group delay ripple have to be achieved at the frequencies given below even if the centre frequency f_c is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_c .

D a t a		typ. value		tolerance / limit		
Insertion loss (reference level)		a_e	11 dB	max.	20	dB
Nominal frequency		f_N	-		174,0	MHz
Centre frequency		f_c	174,0 MHz		-	
Passband		PB	27,5 MHz	$f_N \pm$	12	MHz
Pass band ripple			0,2 dB	max.	1	dB
Bandwidth		BW				
3 dB			29,4 MHz	min.	26	MHz
40 dB			37 MHz		-	
Relative attenuation		a_{rel}				
f_N	$\dots f_N \pm 12$ MHz		0,3 dB	max.	1	dB
$f_N - 30,0$ MHz	$\dots f_N - 20,0$ MHz		46 dB	min.	40	dB
$f_N + 20,0$ MHz	$\dots f_N - 23,5$ MHz		40 dB	min.	37	dB
$f_N + 23,5$ MHz	$\dots f_N + 30,0$ MHz		42 dB	min.	40	dB
Group delay ripple		GD				
f_N	$\dots f_N \pm 12$ MHz		22 ns	max.	80	ns
$f_N \pm 12$ MHz	$\dots f_N \pm 13$ MHz		25 ns	max.	90	ns
Input power level			-	max.	10	dBm
Operating temperature range		OTR	-	- 20 °C .. + 72 °C		
Storage temperature range			-	- 40 °C .. + 85 °C		
Temperature coefficient of frequency		TC_f **	- 92 ppm/K	-		

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

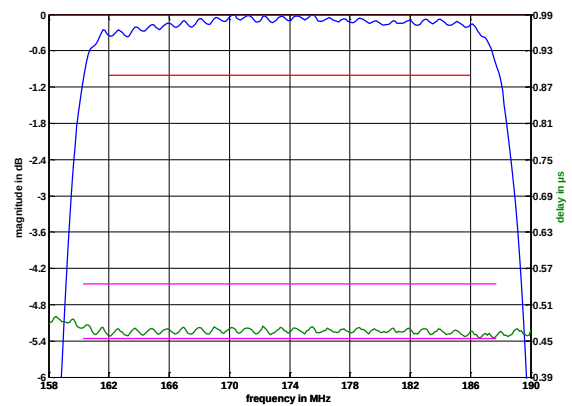
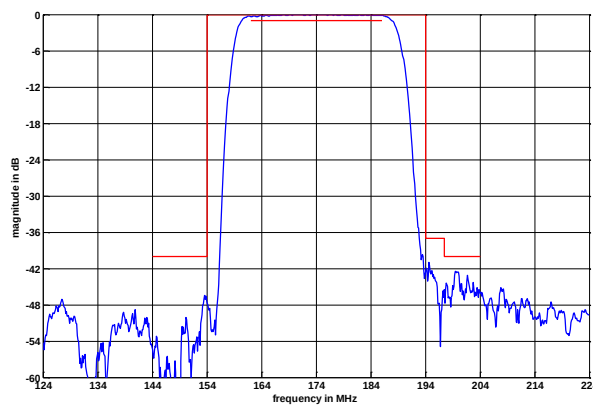
**) $\Delta f_c(\text{Hz}) = TC_f(\text{ppm/K}) \times (T - T_0) \times f_{CAT}(\text{MHz})$.

Generated:

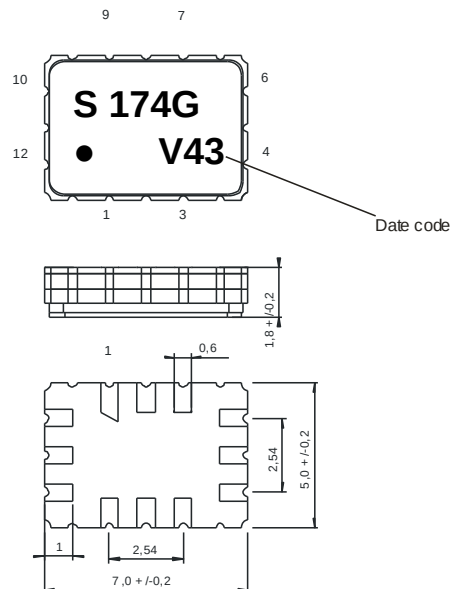
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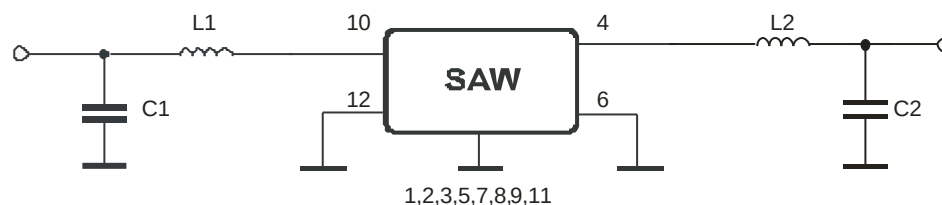
Filter characteristic**Construction and pin connection**

(All dimensions in mm)



1	Ground
2	Ground
3	Ground
4	Output
5	Ground
6	Output RF Return
7	Ground
8	Ground
9	Ground
10	Input
11	Ground
12	Input RF Return

Date code: Year + week
V 2007
W 2008
X 2009
...

50 Ohm Test circuit**Microchip Frequency Technology GmbH****Potsdamer Straße 18****D 14 513 TELTOW / Germany****Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30**

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Microchip**Filter specification****TFS 174G****3/5****Stability characteristics, reliability**

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 30 min. each / 10 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;

This filter is RoHS compliant (2002/95/EG, 2005/618/EG)

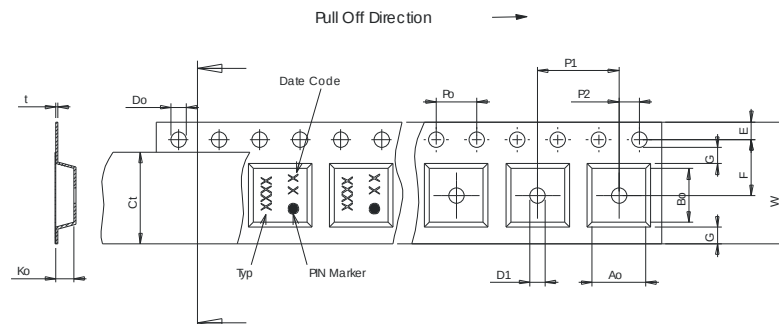
Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

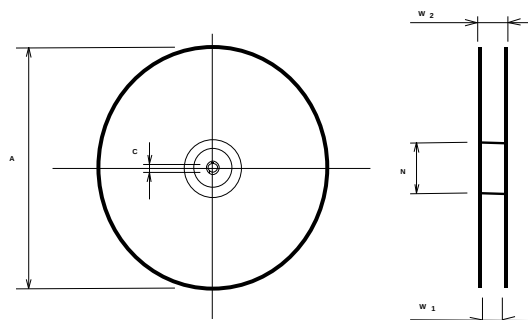
max. pieces of filters per reel:	3000
reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

Tape (all dimensions in mm)

W	: 16,00 ± 0,3
Po	: 4,00 ± 0,1
Do	: 1,50 +0,1/-0
E	: 1,75 ± 0,1
F	: 7,50 ± 0,1
G(min)	: 0,60
P2	: 2,00 ± 0,1
P1	: 8,00 ± 0,1
D1(min)	: 1,50
Ao	: 5,50 ± 0,1
Bo	: 7,50 ± 0,1
Ct	: 13,5 ± 0,1

**Reel (all dimensions in mm)**

A	: 330
W1	: 16,4 +2/-0
W2(max)	: 22,4
N(min)	: 50
C	: 13,0 +0,5/-0,2



The minimum bending radius is 45 mm.

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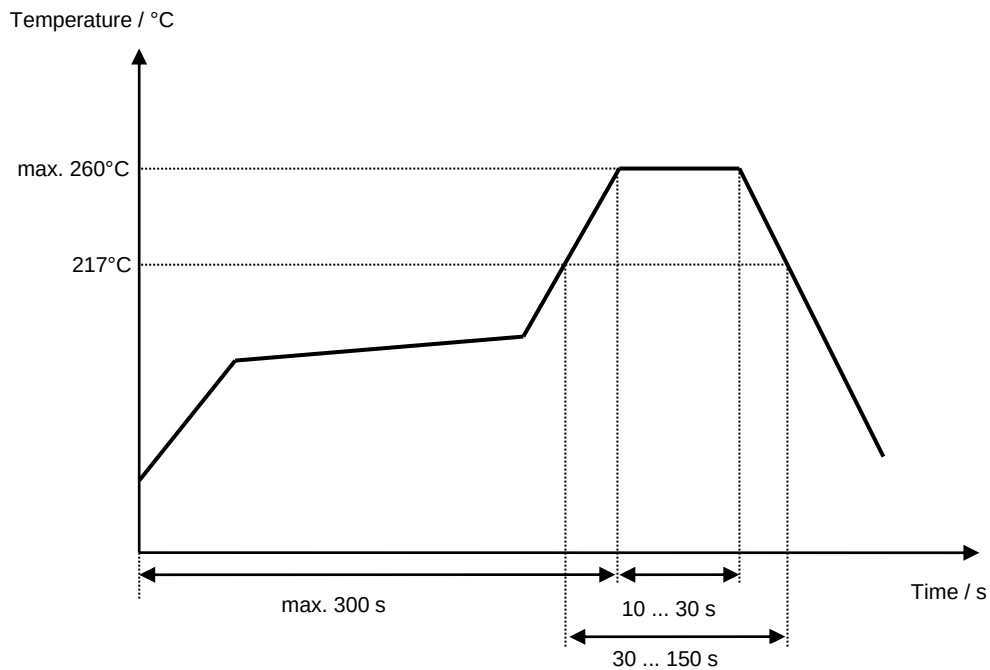
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Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile**Microchip Frequency Technology GmbH****Potsdamer Straße 18****D 14 513 TELTOW / Germany****Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30**

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Microchip**Filter specification****TFS 174G****5/5****History**

Version	Reason of Changes	Name	Date
1.0	- Generation of development specification	Strehl	31.05.2007
1.1	- Change pin connection	Strehl	06.06.2007
1.2	- Change pin connection	Strehl	11.06.2007
1.3	- Correct BW 3 dB	Strehl	21.06.2007
1.4	- Correct construction	Strehl	05.07.2007
1.5	- Created filter specification - Added terminating impedances - Added typical values - Added filter characteristic - Added test circuit	Chilla	26.10.2007

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